

Complementary N- and P-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY				
	V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A) ^a	Q_g (Typ)
N-Channel	40	0.030 at $V_{GS} = 10$ V	8	9.6
		0.034 at $V_{GS} = 4.5$ V	8	
P-Channel	- 40	0.032 at $V_{GS} = - 10$ V	- 8	21
		0.041 at $V_{GS} = - 4.5$ V	- 8	

FEATURES

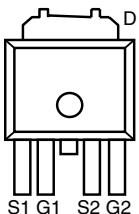
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested



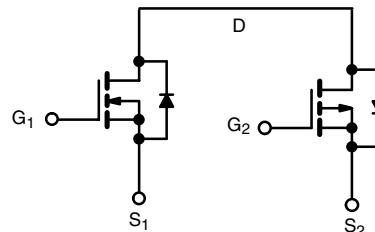
APPLICATIONS

- CCFL Inverter
 - LCD TV and Monitor

TO-252-4L
D-PAK



Top View
Drain Connected to
Tab



Ordering Information: SUD50NP04-62-T4-E3 (Lead (Pb)-free)

N-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V_{DS}	40	- 40	V
Gate-Source Voltage	V_{GS}		± 16	
Continuous Drain Current ($T_J = 150$ °C)	I_D	8	- 8	
		8	- 8	
		8 ^{b, c}	- 8 ^{b, c}	
		8 ^{b, c}	- 8 ^{b, c}	
Pulsed Drain Current (10 μ s Pulse Width)	I_{DM}	35	- 35	A
Source-Drain Current Diode Current	I_S	8	- 8	
		5 ^{b, c}	- 5.5 ^{b, c}	
Pulsed Source-Drain Current	I_{SM}	35	- 35	
Single Pulse Avalanche Current	I_{AS}	10	20	mJ
Single Pulse Avalanche Energy	E_{AS}	5	20	
Maximum Power Dissipation	P_D	15.6	23.5	
		10	15	
		6 ^{b, c}	6.7 ^{b, c}	
		3.9 ^{b, c}	4.3 ^{b, c}	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	N-Channel		P-Channel		Unit
		Typ	Max	Typ	Max	
Maximum Junction-to-Ambient ^{b, d}	R_{thJA}	17	20.5	15.2	18.5	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	6.6	8	4.4	5.3	

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 Board.
- c. t = 10 sec.
- d. Maximum under Steady State conditions is 53 °C/W (N-Channel) and 50 °C/W (P-Channel).

SUD50NP04-62

Vishay Siliconix



SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	N-Ch	40		
		$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	P-Ch	- 40		
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250 \mu\text{A}$	N-Ch		37	
		$I_D = -250 \mu\text{A}$	P-Ch		- 38	
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$	$I_D = 250 \mu\text{A}$	N-Ch		- 5	
		$I_D = -250 \mu\text{A}$	P-Ch		4.0	
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	N-Ch	0.6	2.0	
		$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	P-Ch	- 0.8		- 2.2
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$	N-Ch		100	
			P-Ch		- 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch		1	
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch		- 1	
		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$	N-Ch		10	
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$	P-Ch		- 10	
On-State Drain Current ^b	$I_{D(on)}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	20		
		$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	P-Ch	- 20		A
Drain-Source On-State Resistance ^b	$r_{DS(on)}$	$V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$	N-Ch	0.025	0.030	
		$V_{GS} = -10 \text{ V}, I_D = -6 \text{ A}$	P-Ch	0.026	0.032	
		$V_{GS} = 4.5 \text{ V}, I_D = 4.8 \text{ A}$	N-Ch	0.028	0.034	
		$V_{GS} = -4.5 \text{ V}, I_D = -4.9 \text{ A}$	P-Ch	0.034	0.041	
Forward Transconductance ^b	g_{fs}	$V_{DS} = 15 \text{ V}, I_D = 6 \text{ A}$	N-Ch		20	
		$V_{DS} = -15 \text{ V}, I_D = -6 \text{ A}$	P-Ch		17	S
Dynamic^a						
Input Capacitance	C_{iss}	N-Channel $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	N-Ch		855	
			P-Ch		1505	
Output Capacitance	C_{oss}		N-Ch		105	
			P-Ch		230	pF
Reverse Transfer Capacitance	C_{rss}	P-Channel $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	N-Ch		65	
			P-Ch		175	
Total Gate Charge	Q_g	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	N-Ch		21	32
		$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$	P-Ch		41	62
Gate-Source Charge	Q_{gs}	N-Channel $V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$	N-Ch		9.6	14.5
			P-Ch		21	31
		P-Channel $V_{DS} = -20 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$	N-Ch		2.3	
			P-Ch		4.5	
Gate-Drain Charge	Q_{gd}	$f = 1 \text{ MHz}$	N-Ch		3.2	
			P-Ch		9.2	
Gate Resistance	R_g	$f = 1 \text{ MHz}$	N-Ch		2.5	3.8
			P-Ch		6.5	10

SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit
Dynamic^a						
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20 \text{ V}$, $R_L = 4 \Omega$ $I_D \approx 5 \text{ A}$, $V_{GEN} = 10 \text{ V}$, $R_g = 1 \Omega$	N-Ch	6	12	
			P-Ch	7	14	
Rise Time	t_r		N-Ch	21	32	
			P-Ch	23	35	
Turn-Off Delay Time	$t_{d(off)}$	P-Channel $V_{DD} = -20 \text{ V}$, $R_L = 4 \Omega$ $I_D \approx -5 \text{ A}$, $V_{GEN} = -10 \text{ V}$, $R_g = 1 \Omega$	N-Ch	24	36	
			P-Ch	51	77	
Fall Time	t_f		N-Ch	9	15	
			P-Ch	50	80	ns
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20 \text{ V}$, $R_L = 4 \Omega$ $I_D \approx 5 \text{ A}$, $V_{GEN} = 4.5 \text{ V}$, $R_g = 1 \Omega$	N-Ch	12	20	
			P-Ch	40	60	
Rise Time	t_r		N-Ch	75	115	
			P-Ch	106	160	
Turn-Off Delay Time	$t_{d(off)}$	P-Channel $V_{DD} = -20 \text{ V}$, $R_L = 4 \Omega$ $I_D \approx -5 \text{ A}$, $V_{GEN} = -4.5 \text{ V}$, $R_g = 1 \Omega$	N-Ch	40	60	
			P-Ch	45	70	
Fall Time	t_f		N-Ch	56	85	
			P-Ch	50	75	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	$T_C = 25^\circ\text{C}$	N-Ch		8	
			P-Ch		-8	A
Pulse Diode Forward Current ^a	I_{SM}		N-Ch		35	
			P-Ch		-35	
Body Diode Voltage	V_{SD}	$I_S = 1.5 \text{ A}$	N-Ch	0.73	1.2	
		$I_S = -1.6 \text{ A}$	P-Ch	-0.73	-1.2	V
Body Diode Reverse Recovery Time	t_{rr}	$N\text{-Channel}$ $I_F = 5 \text{ A}$, $di/dt = 100 \text{ A}/\mu\text{s}$, $T_J = 25^\circ\text{C}$	N-Ch	26	40	
			P-Ch	30	45	ns
Body Diode Reverse Recovery Charge	Q_{rr}		N-Ch	21	32	
			P-Ch	24	36	nC
Reverse Recovery Fall Time	t_a	$P\text{-Channel}$ $I_F = -5 \text{ A}$, $di/dt = -100 \text{ A}/\mu\text{s}$, $T_J = 25^\circ\text{C}$	N-Ch	13		
			P-Ch	15		
Reverse Recovery Rise Time	t_b		N-Ch	13		
			P-Ch	15		ns

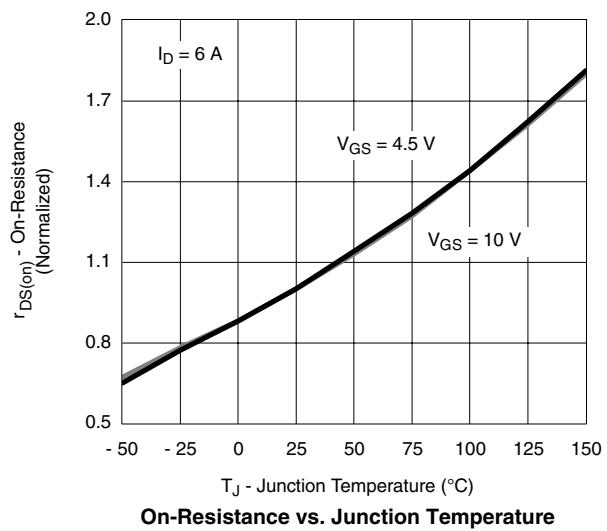
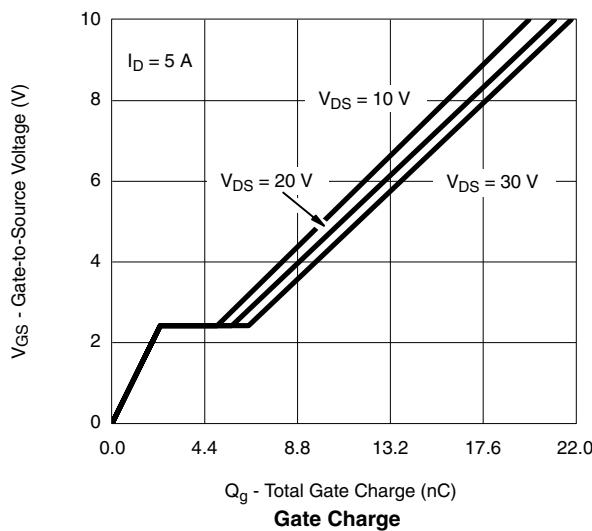
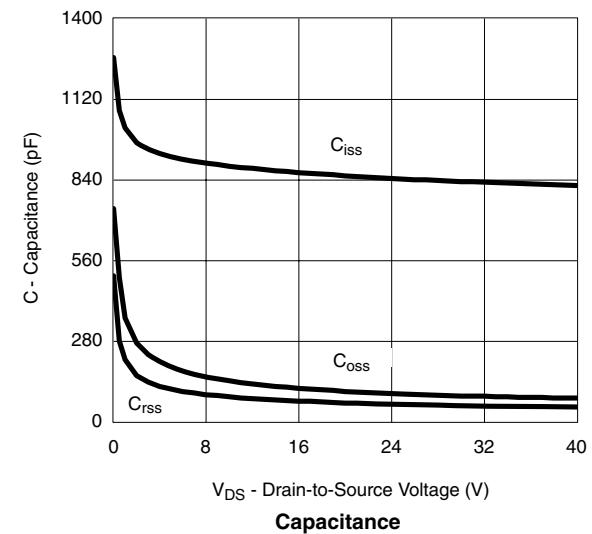
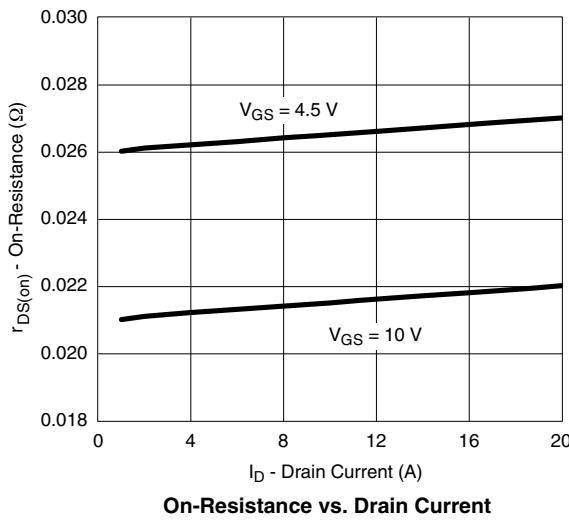
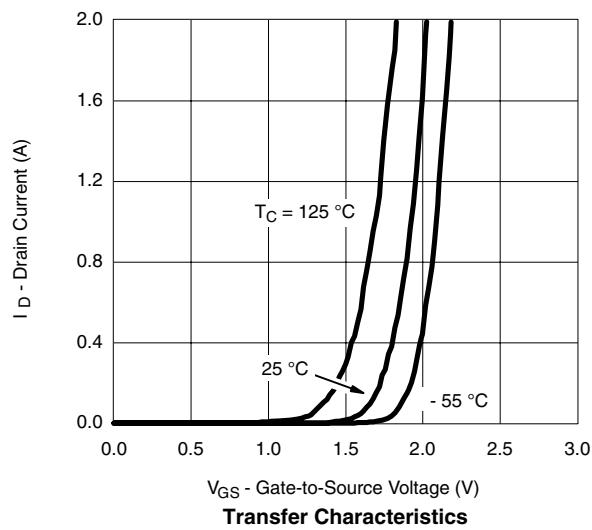
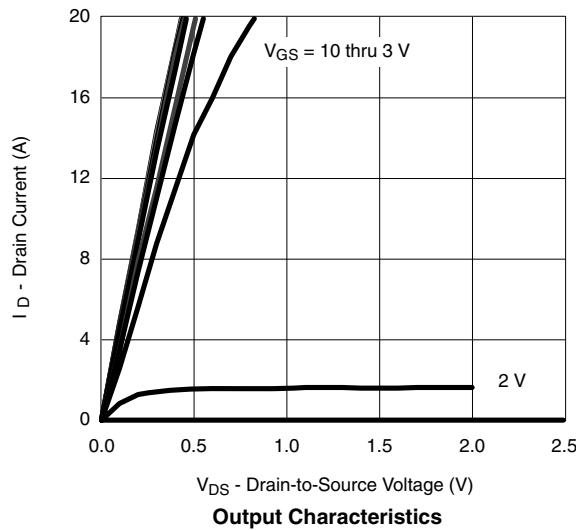
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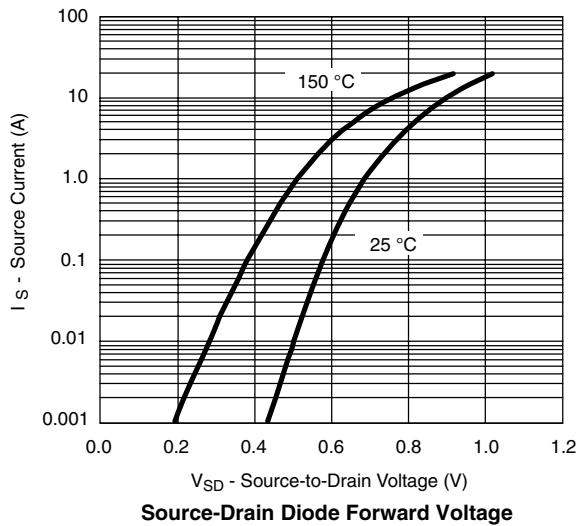
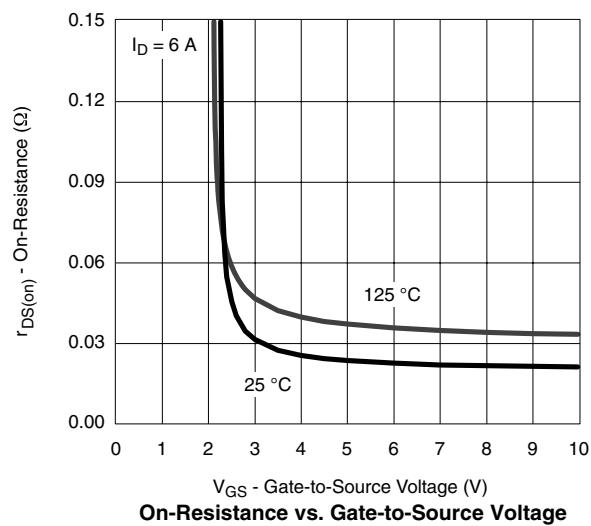
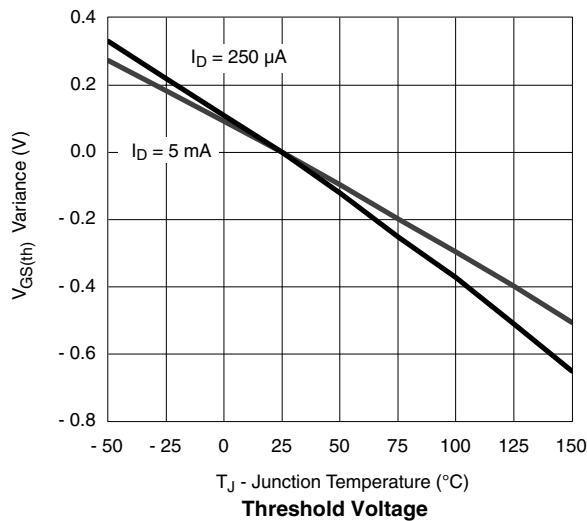
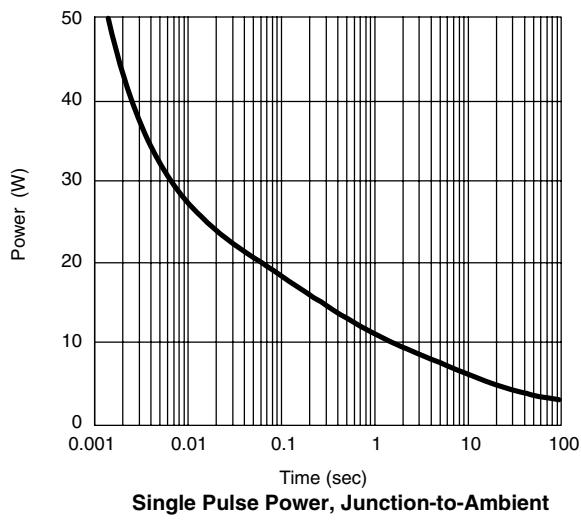
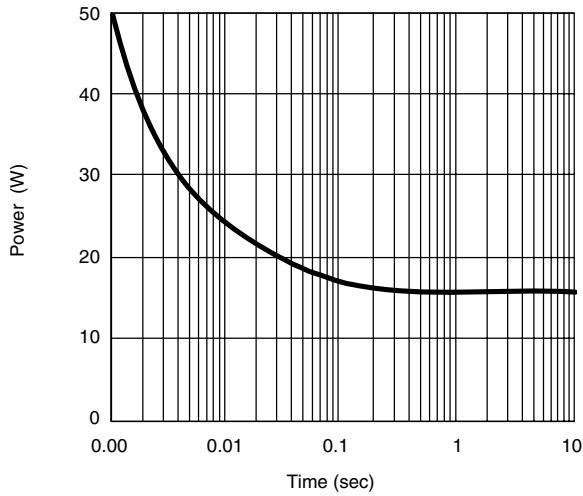
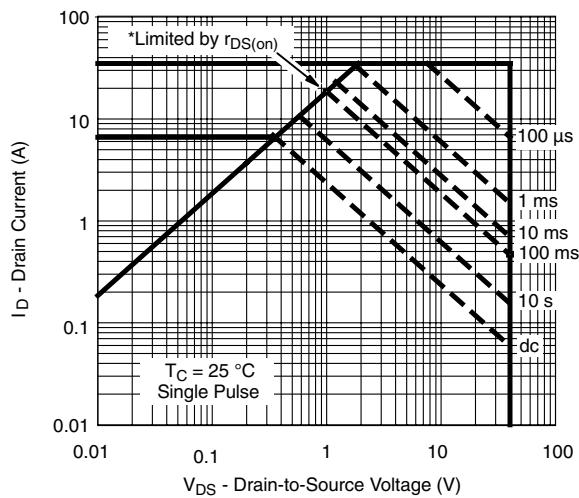
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

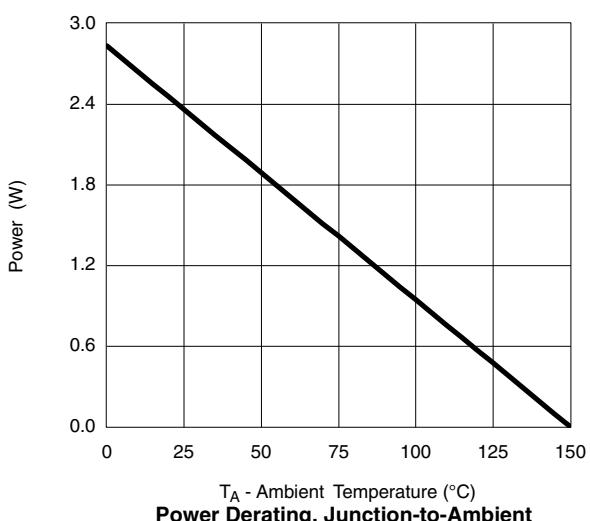
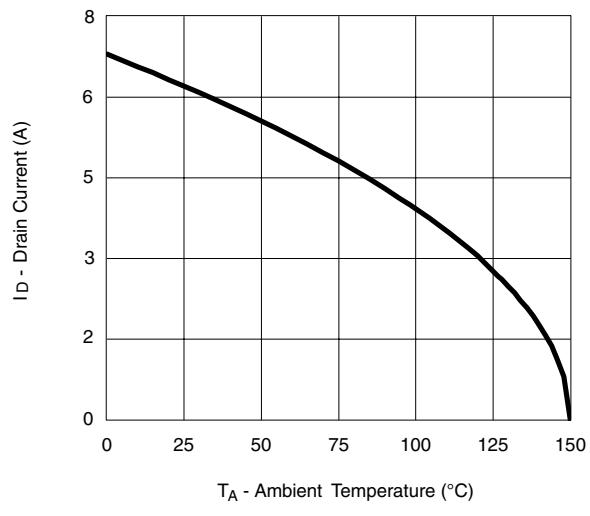
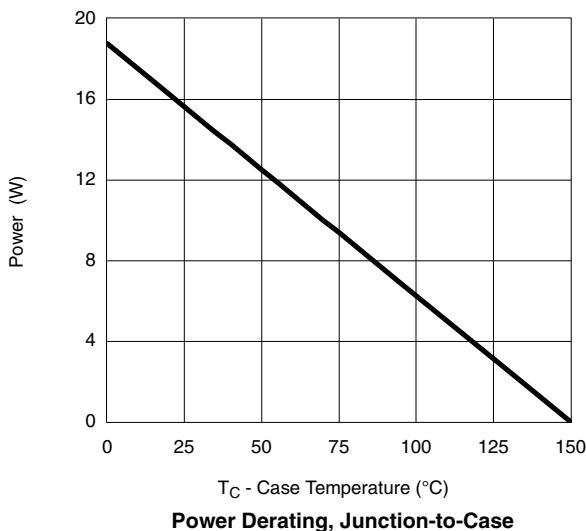
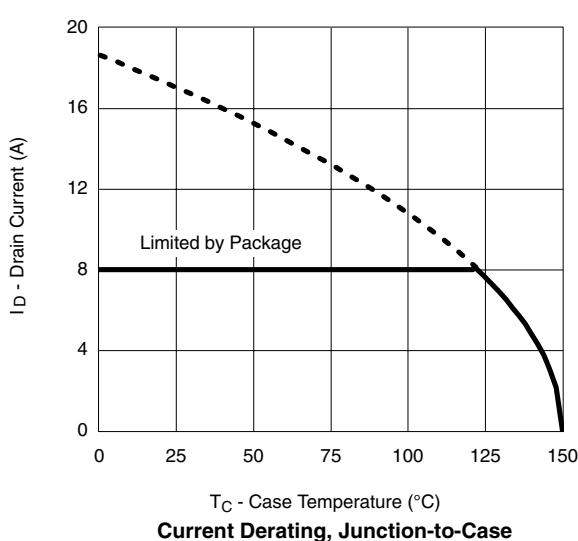
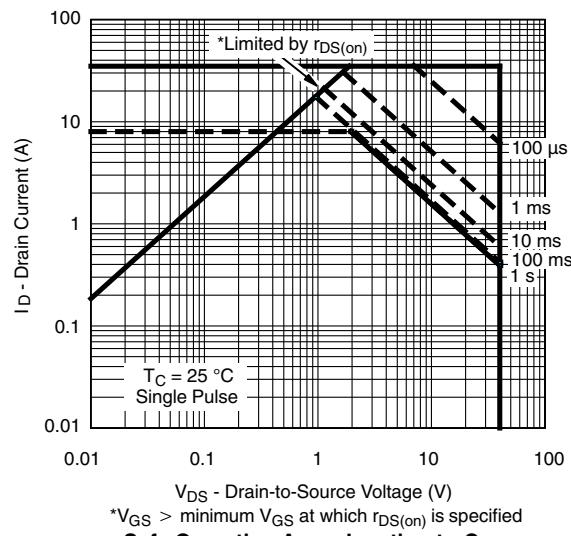
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted



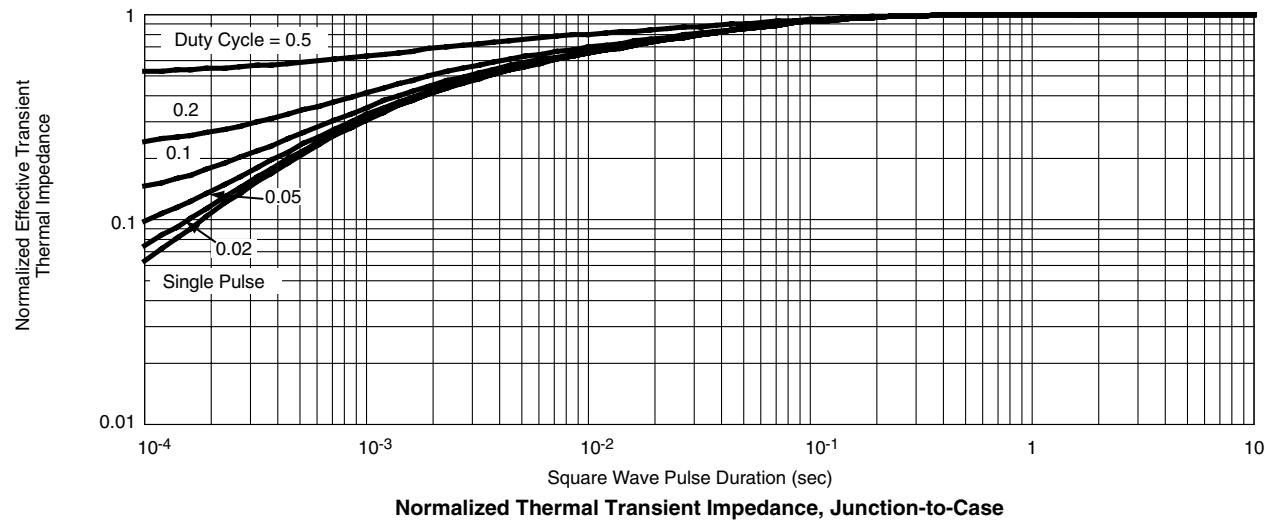
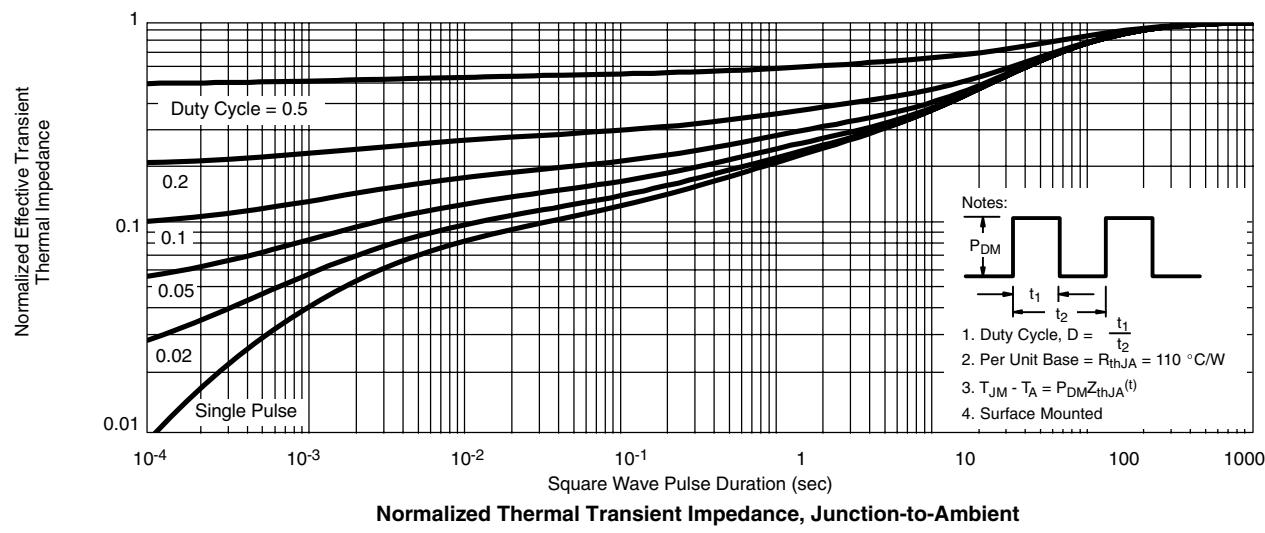
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Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Single Pulse Power, Junction-to-Ambient

Single Pulse Power, Junction-to-Case

* $V_{GS} >$ minimum V_{GS} at which $r_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

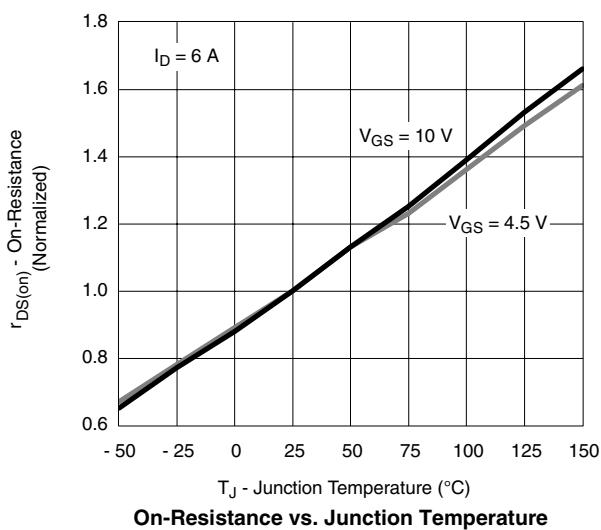
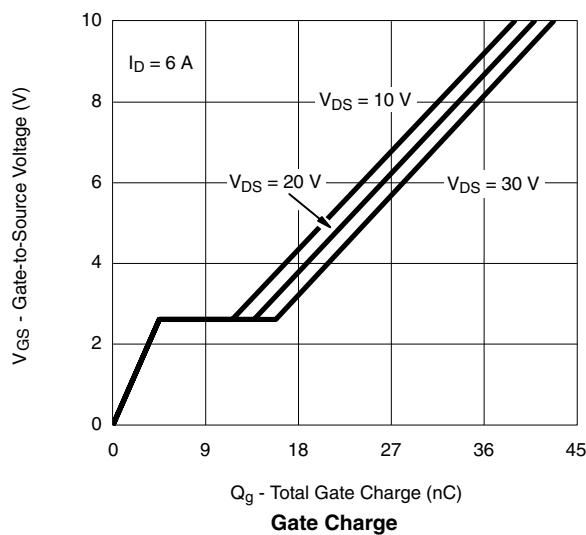
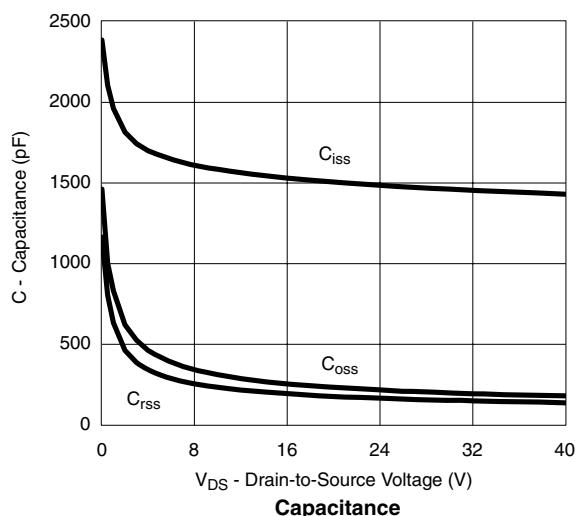
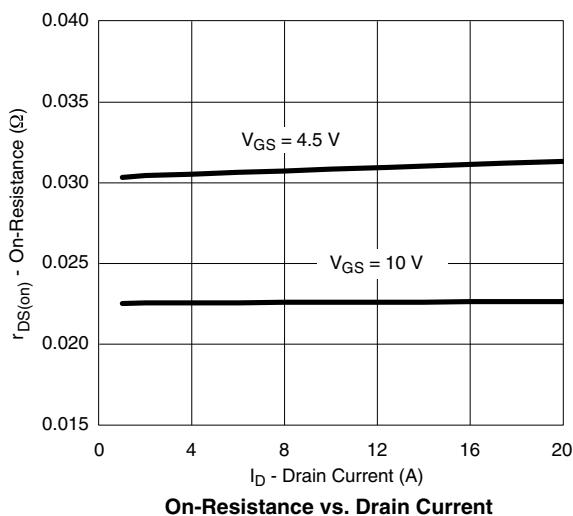
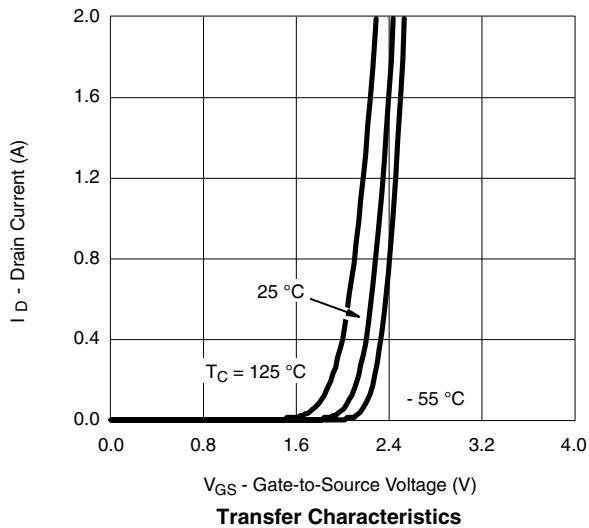
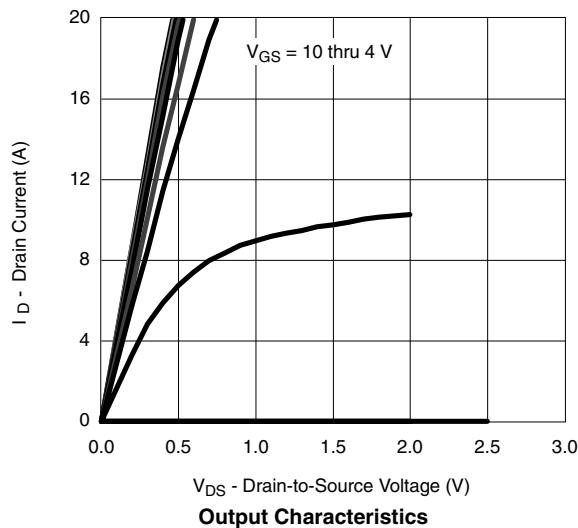
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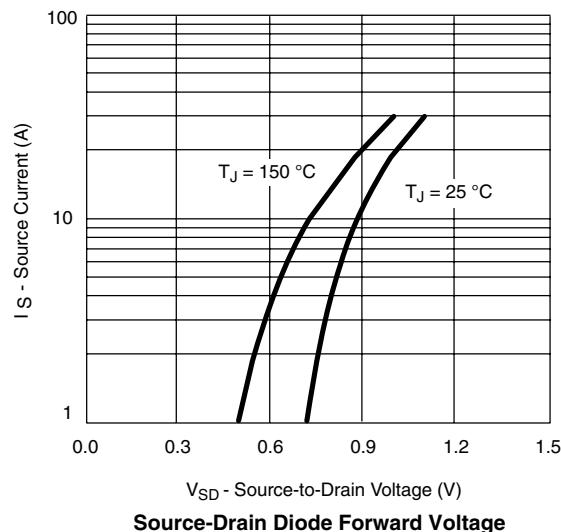
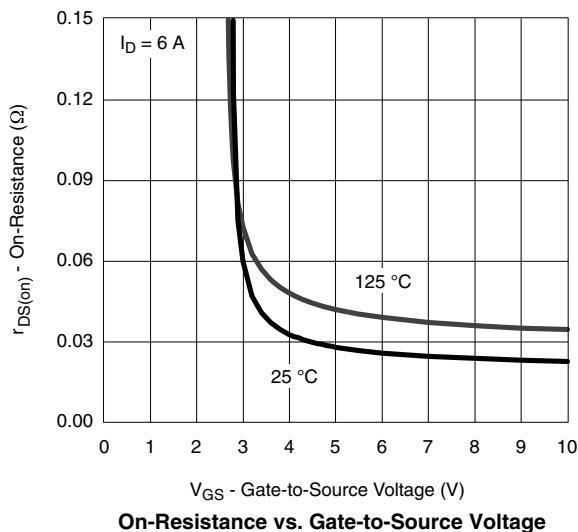
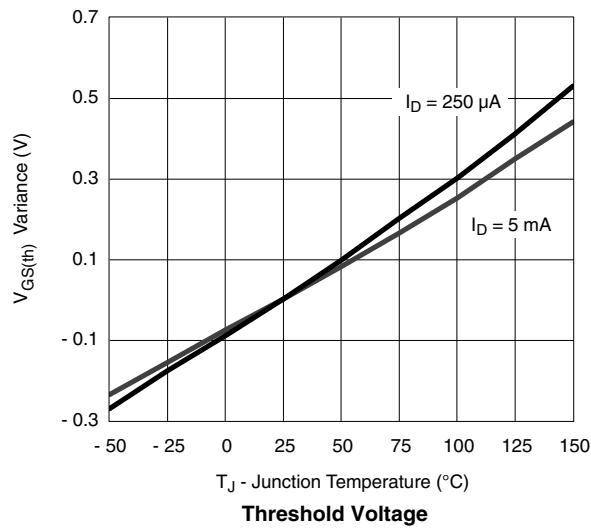
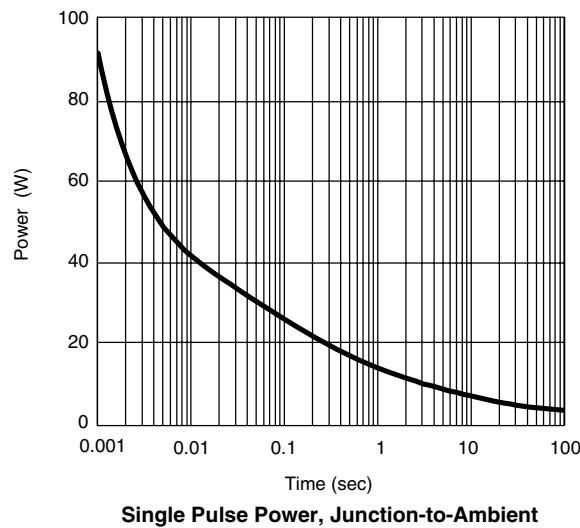
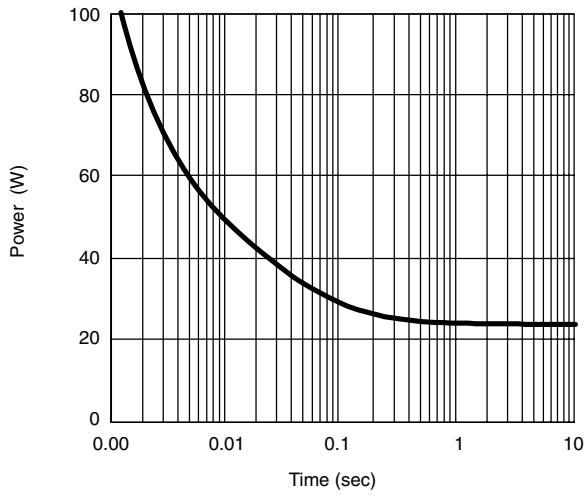
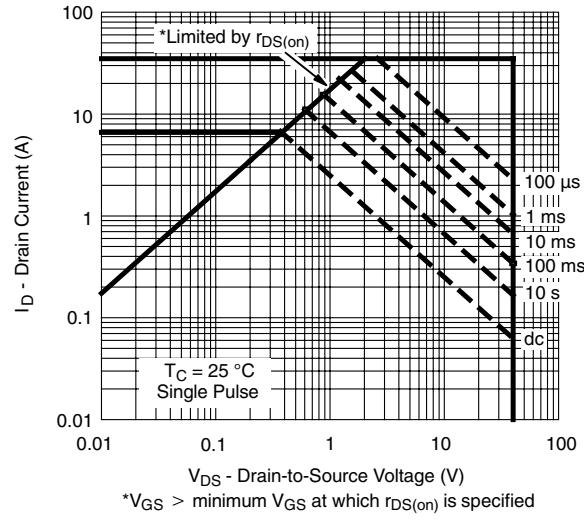


*The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

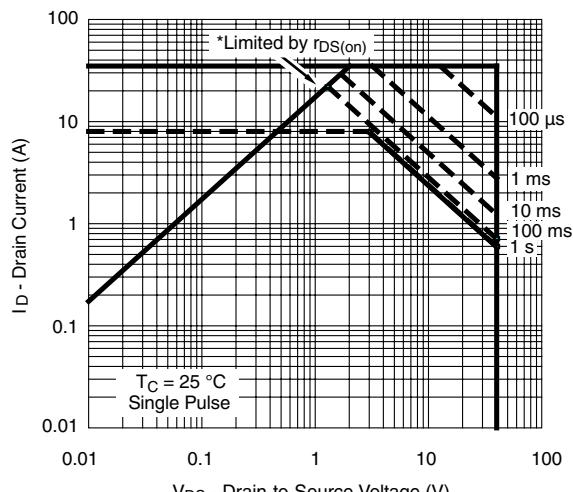
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted

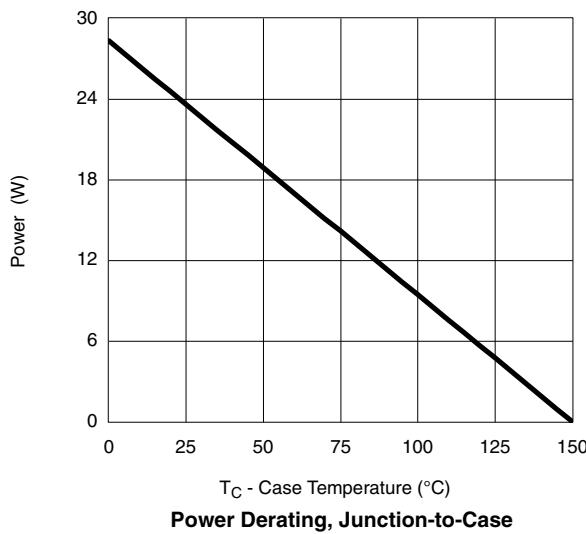
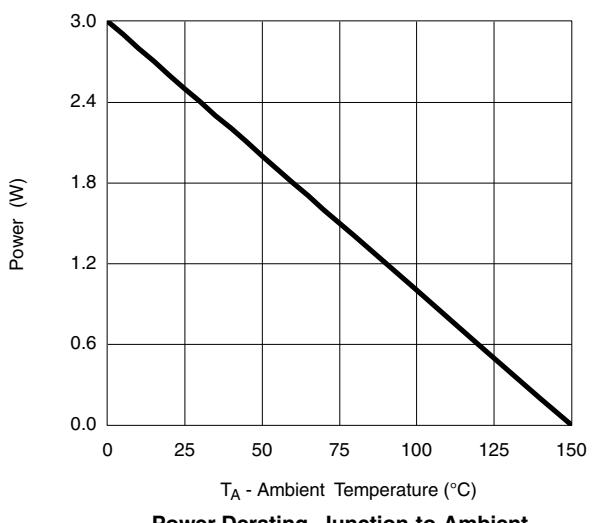
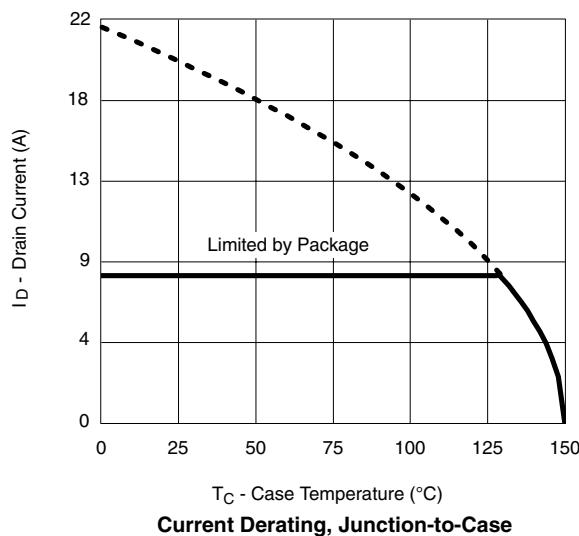
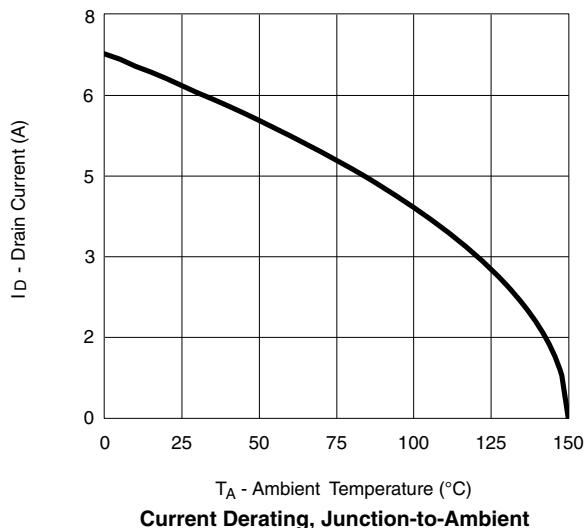


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted

Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Single Pulse Power, Junction-to-Ambient

Single Pulse Power, Junction-to-Case

Safe Operating Area, Junction-to-Ambient

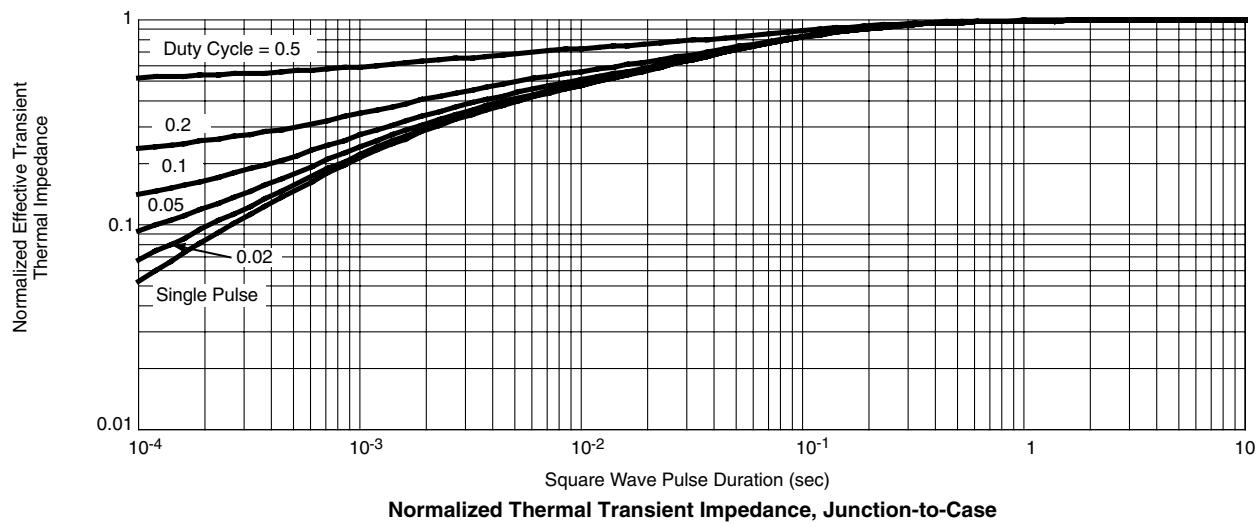
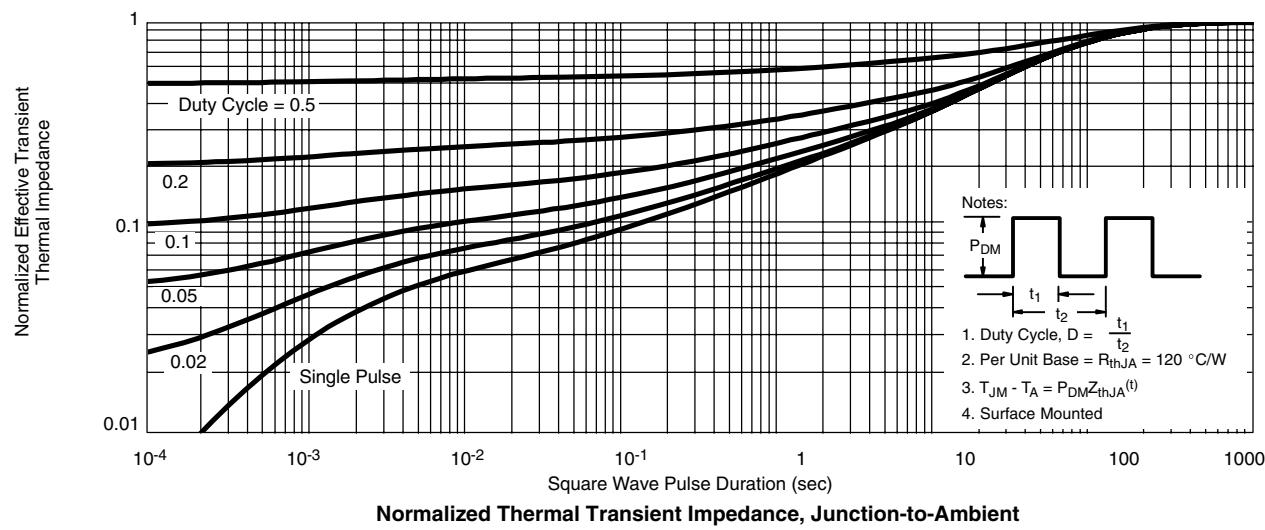
P-CHANNEL TYPICAL CHARACTERISTICS 25°C , unless noted



* $V_{GS} >$ minimum V_{GS} at which $r_{DS(on)}$ is specified
Safe Operating Area, Junction-to-Case



*The power dissipation P_D is based on $T_{J(max)} = 150^{\circ}\text{C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted


Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <http://www.vishay.com/ppg774401>.



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- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помошь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помошь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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